TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL JUNCTION TYPE

2 S K 1 8 4

LOW NOISE AUDIO AMPLIFIER APPLICATIONS

• High $|Y_{fs}| : |Y_{fs}| = 15 \text{mS} \text{ (Typ.) (V}_{DS} = 10 \text{V, V}_{GS} = 0)$

High Breakdown Voltage : V_{GDS} = −50V

• Low Noise: NF=1.0dB (Typ.)

 $(V_{DS}=10V, I_{D}=0.5mA, f=1kHz, R_{G}=1k\Omega)$

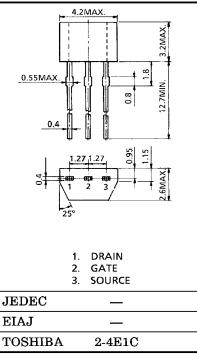
• High Input Impedance : $I_{GSS} = -1nA \text{ (Max.) (V}_{GS} = -30V)$

• Small Package

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Gate-Drain Voltage	v_{GDS}	-50	V
Gate Current	$I_{\mathbf{G}}$	10	mA
Drain Power Dissipation	$P_{\mathbf{D}}$	200	mW
Junction Temperature	T_{j}	125	°C
Storage Temperature Range	$\mathrm{T_{stg}}$	-55~125	°C

Unit in mm



Weight: 0.13g

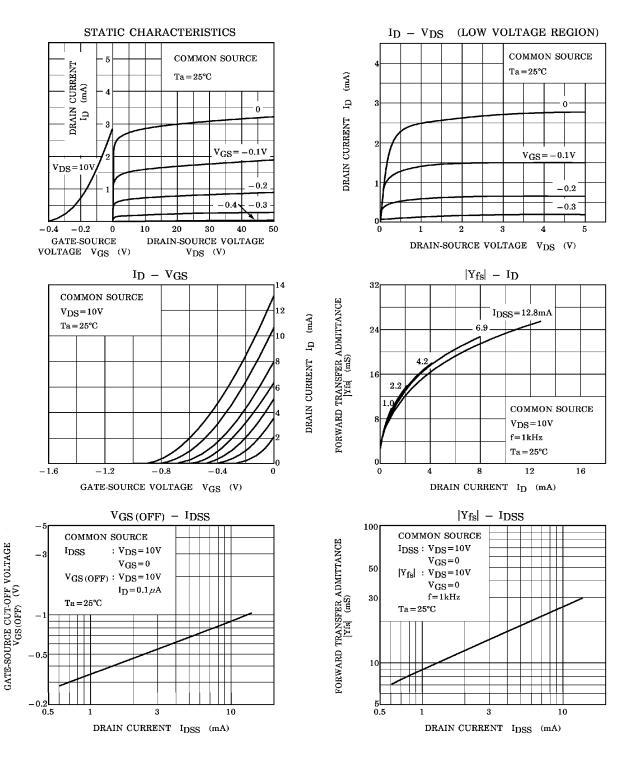
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Cut-off Current	${ m I}_{ m GSS}$	$V_{GS} = -30V, V_{DS} = 0$	_	_	-1.0	nA
Gate-Drain Breakdown Voltage	V (BR) GDS	$V_{DS} = 0, I_G = -100 \mu A$	-50	_	_	V
Drain Current	I _{DSS} (Note)	$V_{\mathrm{DS}} = 10 V, V_{\mathrm{GS}} = 0$	1.2	_	14.0	mA
Gate-Source Cut-off Voltage	V _{GS} (OFF)	$V_{DS} = 10V, I_{D} = 0.1 \mu A$	-0.2	_	-1.5	V
Forward Transfer Admittance	Yfs	$V_{ m DS} = 10 V, \ V_{ m GS} = 0, \ f = 1 { m kHz}$	4.0	15	_	mS
Input Capacitance	Ciss	$V_{DS} = 10V, V_{GS} = 0, f = 1MHz$	_	13	_	pF
Reverse Transfer Capacitance	C_{rss}	$V_{ m DG} = 10 V, \; I_{ m D} = 0, \; f = 1 M { m Hz}$	_	3	_	рF
Noise Figure	NF (1)	V_{DS} =10V, R _G =1k Ω , I _D =0.5mA, f=10Hz	_	5	10	JD
	NF (2)	$egin{aligned} & V_{DS} = 10V, \ R_G = 1k\Omega, \ & I_D = 0.5 mA, \ f = 1 kHz \end{aligned}$	_	1	2	dB

Note :IDSS Classification Y: 1.2~3.0mA, GR: 2.6~6.5mA, BL: 6.0~14.0mA

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